

GaAs INTEGRATED CIRCUIT

μ PG2159T6R

L, S-BAND SPDT SWITCH

DESCRIPTION

The μ PG2159T6R is a GaAs MMIC for L, S-band SPDT (Single Pole Double Throw) switch which was developed for mobile phone and another L, S-band applications.

This device can operate 2 control switching by control voltage 1.8 to 3.3 V. This device can operate frequency from 0.05 GHz to 3.0 GHz, having the low insertion loss and high isolation.

This device is housed in a 6-pin plastic TSSON (Thin Shrink Small Out-line Non-leaded) (T6R) package. And this package is able to high-density surface mounting.

FEATURES

- Switch control voltage : $V_{\text{cont}}(\text{H}) = 1.8 \text{ to } 3.3 \text{ V}$ (2.7 V TYP.)
: $V_{\text{cont}}(\text{L}) = -0.2 \text{ to } 0.2 \text{ V}$ (0 V TYP.)
- Low insertion loss : $L_{\text{ins1}} = 0.20 \text{ dB TYP. @ } f = 0.05 \text{ to } 0.5 \text{ GHz, } V_{\text{cont}}(\text{H}) = 2.7 \text{ V, } V_{\text{cont}}(\text{L}) = 0 \text{ V}$
: $L_{\text{ins2}} = 0.21 \text{ dB TYP. @ } f = 0.5 \text{ to } 1.0 \text{ GHz, } V_{\text{cont}}(\text{H}) = 2.7 \text{ V, } V_{\text{cont}}(\text{L}) = 0 \text{ V}$
: $L_{\text{ins3}} = 0.23 \text{ dB TYP. @ } f = 1.0 \text{ to } 2.0 \text{ GHz, } V_{\text{cont}}(\text{H}) = 2.7 \text{ V, } V_{\text{cont}}(\text{L}) = 0 \text{ V}$
: $L_{\text{ins4}} = 0.25 \text{ dB TYP. @ } f = 2.0 \text{ to } 2.5 \text{ GHz, } V_{\text{cont}}(\text{H}) = 2.7 \text{ V, } V_{\text{cont}}(\text{L}) = 0 \text{ V}$
: $L_{\text{ins5}} = 0.27 \text{ dB TYP. @ } f = 2.5 \text{ to } 3.0 \text{ GHz, } V_{\text{cont}}(\text{H}) = 2.7 \text{ V, } V_{\text{cont}}(\text{L}) = 0 \text{ V}$
- High isolation : $\text{ISL1} = 27 \text{ dB TYP. @ } f = 0.05 \text{ to } 0.5 \text{ GHz, } V_{\text{cont}}(\text{H}) = 2.7 \text{ V, } V_{\text{cont}}(\text{L}) = 0 \text{ V}$
: $\text{ISL2} = 27 \text{ dB TYP. @ } f = 0.5 \text{ to } 1.0 \text{ GHz, } V_{\text{cont}}(\text{H}) = 2.7 \text{ V, } V_{\text{cont}}(\text{L}) = 0 \text{ V}$
: $\text{ISL3} = 27 \text{ dB TYP. @ } f = 1.0 \text{ to } 2.0 \text{ GHz, } V_{\text{cont}}(\text{H}) = 2.7 \text{ V, } V_{\text{cont}}(\text{L}) = 0 \text{ V}$
: $\text{ISL4} = 27 \text{ dB TYP. @ } f = 2.0 \text{ to } 2.5 \text{ GHz, } V_{\text{cont}}(\text{H}) = 2.7 \text{ V, } V_{\text{cont}}(\text{L}) = 0 \text{ V}$
: $\text{ISL5} = 27 \text{ dB TYP. @ } f = 2.5 \text{ to } 3.0 \text{ GHz, } V_{\text{cont}}(\text{H}) = 2.7 \text{ V, } V_{\text{cont}}(\text{L}) = 0 \text{ V}$
- Handling power : $P_{\text{in}}(1 \text{ dB}) = +25.5 \text{ dBm TYP. @ } f = 0.5 \text{ to } 3.0 \text{ GHz, } V_{\text{cont}}(\text{H}) = 2.7 \text{ V, } V_{\text{cont}}(\text{L}) = 0 \text{ V}$
: $P_{\text{in}}(0.1 \text{ dB}) = +22.0 \text{ dBm TYP. @ } f = 0.5 \text{ to } 3.0 \text{ GHz, } V_{\text{cont}}(\text{H}) = 2.7 \text{ V, } V_{\text{cont}}(\text{L}) = 0 \text{ V}$
- High-density surface mounting : 6-pin plastic TSSON (T6R) package (1.0 × 1.0 × 0.37 mm)

APPLICATIONS

- L, S-band digital cellular or cordless telephone
- W-LAN and Bluetooth™

ORDERING INFORMATION

Part Number	Order Number	Package	Marking	Supplying Form
μ PG2159T6R-E2	μ PG2159T6R-E2-A	6-pin plastic TSSON (T6R) (Pb-Free)	G7	- Embossed tape 8 mm wide - Pin 1, 6 face the perforation side of the tape - Qty 5 kpcs/reel

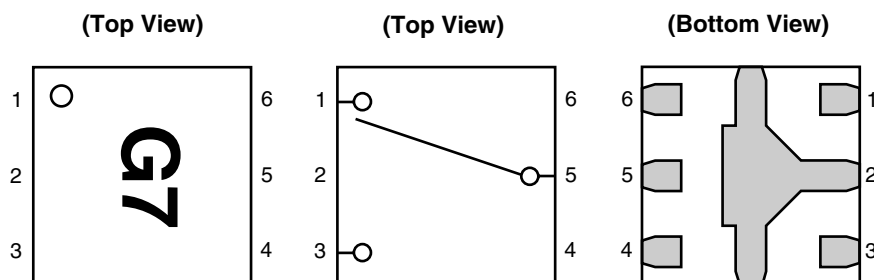
Remark To order evaluation samples, contact your nearby sales office.

Part number for sample order: μ PG2159T6R

Caution Although this device is designed to be as robust as possible, ESD (Electrostatic Discharge) can damage this device. This device must be protected at all times from ESD. Static charges may easily produce potentials of several kilovolts on the human body or equipment, which can discharge without detection. Industry-standard ESD precautions must be employed at all times.

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PIN CONNECTIONS AND INTERNAL BLOCK DIAGRAM



Pin No.	Pin Name
1	OUTPUT1
2	GND
3	OUTPUT2
4	V _{cont2}
5	INPUT
6	V _{cont1}

Remark Exposed pad : GND

TRUTH TABLE

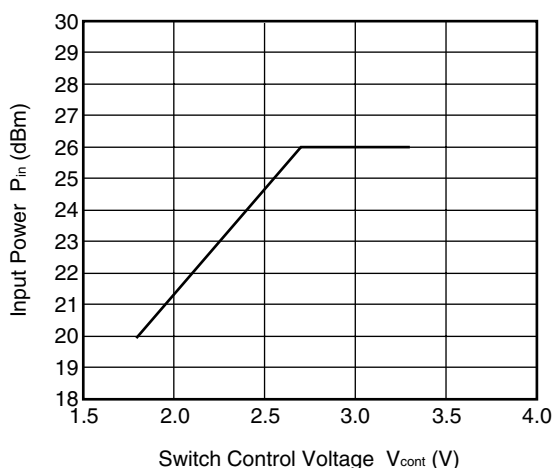
V _{cont1}	V _{cont2}	INPUT-OUTPUT1	INPUT-OUTPUT2
Low	High	OFF	ON
High	Low	ON	OFF

ABSOLUTE MAXIMUM RATINGS (T_A = +25°C, unless otherwise specified)

Parameter	Symbol	Ratings	Unit
Switch Control Voltage	V _{cont}	6.0 ^{Note1}	V
Input Power	P _{in}	+26.0 ^{Note2, 4}	dBm
Input Power	P _{in}	+8 + V _{cont} * 20/3 ^{Note3, 4}	dBm
Operating Ambient Temperature	T _A	-45 to +85	°C
Storage Temperature	T _{stg}	-55 to +150	°C

- Notes 1.** $|V_{cont1} - V_{cont2}| \leq 6.0 \text{ V}$
2. $2.7 \text{ V} \leq |V_{cont1} - V_{cont2}| \leq 3.3 \text{ V}$
3. $1.8 \text{ V} \leq |V_{cont1} - V_{cont2}| \leq 2.7 \text{ V}$
4. Please refer to following chart.

INPUT POWER vs.
SWITCH CONTROL VOLTAGE



Remark The graph indicates nominal characteristics.

RECOMMENDED OPERATING RANGE (T_A = +25°C, unless otherwise specified)

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Switch Control Voltage (H)	V _{cont} (H)	1.8	2.7	3.3	V
Switch Control Voltage (L)	V _{cont} (L)	−0.2	0	+0.2	V

ELECTRICAL CHARACTERISTICS 1

(T_A = +25°C, V_{cont} (H) = 2.7 V, V_{cont} (L) = 0 V, DC cut capacitors = 56 pF, unless otherwise specified)

Parameter	Symbol	Test Conditions	MIN.	TYP.	MAX.	Unit
Insertion Loss 1	L _{ins1}	f = 0.05 to 0.5 GHz ^{Note1}	–	0.20	0.35	dB
Insertion Loss 2	L _{ins2}	f = 0.5 to 1.0 GHz	–	0.21	0.35	dB
Insertion Loss 3	L _{ins3}	f = 1.0 to 2.0 GHz	–	0.23	0.40	dB
Insertion Loss 4	L _{ins4}	f = 2.0 to 2.5 GHz	–	0.25	0.42	dB
Insertion Loss 5	L _{ins5}	f = 2.5 to 3.0 GHz	–	0.27	0.45	dB
Isolation 1	ISL1	f = 0.05 to 0.5 GHz ^{Note1}	24	27	–	dB
Isolation 2	ISL2	f = 0.5 to 1.0 GHz	24	27	–	dB
Isolation 3	ISL3	f = 1.0 to 2.0 GHz	24	27	–	dB
Isolation 4	ISL4	f = 2.0 to 2.5 GHz	24	27	–	dB
Isolation 5	ISL5	f = 2.5 to 3.0 GHz	24	27	–	dB
Input Return Loss 1	RL _{in1}	f = 0.05 to 0.5 GHz ^{Note1}	15	20	–	dB
Input Return Loss 2	RL _{in2}	f = 0.5 to 3.0 GHz	15	20	–	dB
Output Return Loss 1	RL _{out1}	f = 0.05 to 0.5 GHz ^{Note1}	15	20	–	dB
Output Return Loss 2	RL _{out2}	f = 0.5 to 3.0 GHz	15	20	–	dB
0.1 dB Loss Compression Input Power ^{Note2}	P _{in} (0.1 dB)	f = 2.0 GHz/2.5 GHz	+20.0	+22.0	–	dBm
		f = 0.5 to 3.0 GHz	–	+22.0	–	dBm
1 dB Loss Compression Input Power ^{Note3}	P _{in} (1 dB)	f = 0.5 to 3.0 GHz	–	+25.5	–	dBm
2nd Harmonics	2f ₀	f = 2.0 GHz/2.5 GHz, P _{in} = +10 dBm	65	77	–	dBc
3rd Harmonics	3f ₀	f = 2.0 GHz/2.5 GHz, P _{in} = +10 dBm	60	80	–	dBc
Input 3rd Order Intercept Point	IIP ₃	f = 0.5 to 3.0 GHz, 2 tone 5 MHz spacing	–	+49.0	–	dBm
Switch Control Current	I _{cont}		–	0.2	1.0	μA
Switch Control Speed	t _{sw}	50% CTL to 90/10%	–	20	200	ns

Notes 1. DC cut capacitors = 1 000 pF at f = 0.05 to 0.5 GHz

2. P_{in} (0.1 dB) is measured the input power level when the insertion loss increases more 0.1 dB than that of linear range.

3. P_{in} (1 dB) is measured the input power level when the insertion loss increases more 1 dB than that of linear range.

Caution This device is used it is necessary to use DC cut capacitors.

ELECTRICAL CHARACTERISTICS 2

(T_A = +25°C, V_{cont} (H) = 1.8 V, V_{cont} (L) = 0 V, DC cut capacitors = 56 pF, unless otherwise specified)

Parameter	Symbol	Test Conditions	MIN.	TYP.	MAX.	Unit
Insertion Loss 6	L _{ins6}	f = 0.05 to 0.5 GHz ^{Note1}	–	0.21	0.36	dB
Insertion Loss 7	L _{ins7}	f = 0.5 to 1.0 GHz	–	0.22	0.37	dB
Insertion Loss 8	L _{ins8}	f = 1.0 to 2.0 GHz	–	0.24	0.41	dB
Insertion Loss 9	L _{ins9}	f = 2.0 to 2.5 GHz	–	0.26	0.43	dB
Insertion Loss 10	L _{ins10}	f = 2.5 to 3.0 GHz	–	0.28	0.46	dB
Isolation 6	ISL6	f = 0.05 to 0.5 GHz ^{Note1}	23	26	–	dB
Isolation 7	ISL7	f = 0.5 to 1.0 GHz	23	26	–	dB
Isolation 8	ISL8	f = 1.0 to 2.0 GHz	23	26	–	dB
Isolation 9	ISL9	f = 2.0 to 2.5 GHz	23	26	–	dB
Isolation 10	ISL10	f = 2.5 to 3.0 GHz	23	26	–	dB
Input Return Loss 3	RL _{in3}	f = 0.05 to 0.5 GHz ^{Note1}	15	20	–	dB
Input Return Loss 4	RL _{in4}	f = 0.5 to 3.0 GHz	15	20	–	dB
Output Return Loss 3	RL _{out3}	f = 0.05 to 0.5 GHz ^{Note1}	15	20	–	dB
Output Return Loss 4	RL _{out4}	f = 0.5 to 3.0 GHz	15	20	–	dB
0.1 dB Loss Compression Input Power ^{Note2}	P _{in} (0.1 dB)	f = 2.0 GHz/2.5 GHz	+12	+15.5	–	dBm
		f = 0.5 to 3.0 GHz	–	+15.5	–	dBm
1 dB Loss Compression Input Power ^{Note3}	P _{in} (1 dB)	f = 0.5 to 3.0 GHz	–	+19.5	–	dBm
Switch Control Current	I _{cont}	RF None	–	0.2	1.0	μA
Switch Control Speed	t _{sw}	50% CTL to 90/10% RF	–	20	200	ns

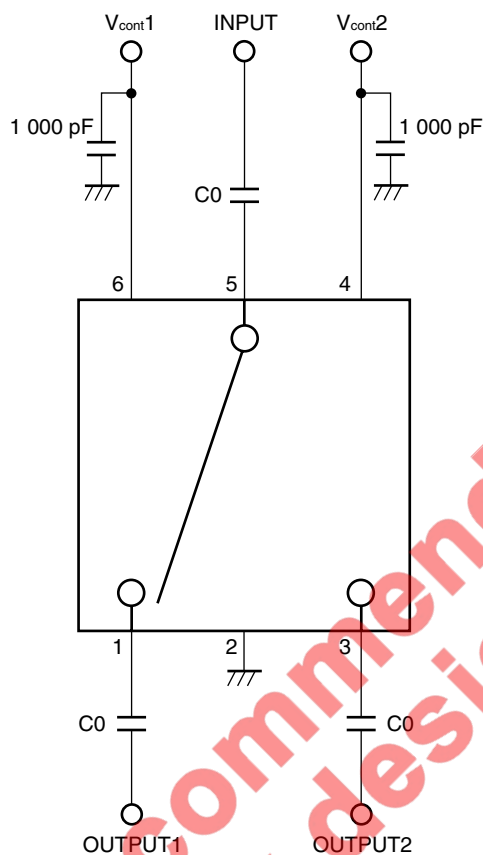
Notes 1. DC cut capacitors = 1 000 pF at f = 0.05 to 0.5 GHz

2. P_{in} (0.1 dB) is measured the input power level when the insertion loss increases more 0.1 dB than that of linear range.

3. P_{in} (1 dB) is measured the input power level when the insertion loss increases more 1 dB than that of linear range.

Caution This device is used it is necessary to use DC cut capacitors.

EVALUATION CIRCUIT



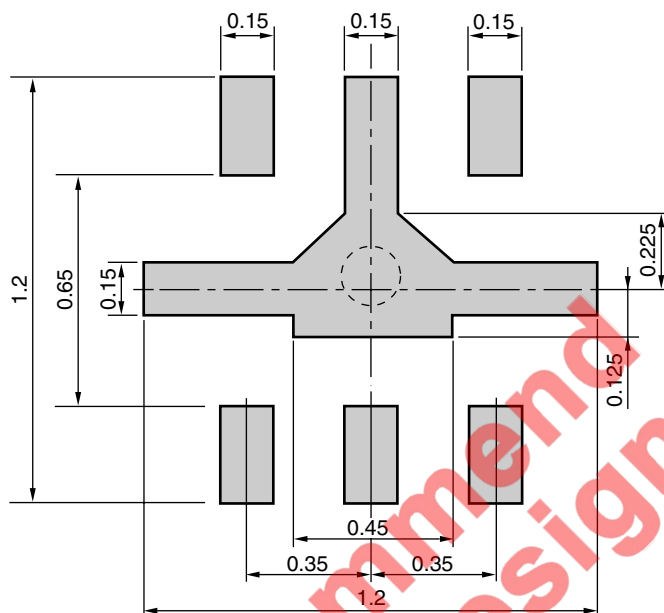
Remark C0 : 0.05 to 0.5 GHz 1 000 pF
: 0.5 to 3.0 GHz 56 pF

The application circuits and their parameters are for reference only and are not intended for use in actual design-ins.

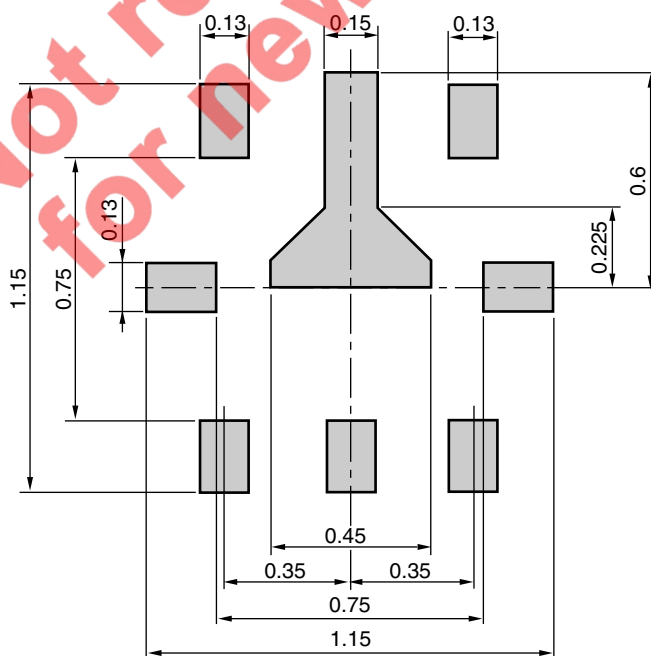
MOUNTING PAD AND SOLDER MASK LAYOUT DIMENSIONS

6-PIN PLASTIC TSSON (T6R) (UNIT: mm)

MOUNTING PAD



SOLDER MASK



Solder thickness : 0.08 mm

Remark The mounting pad and solder mask layouts in this document are for reference only.

6-PIN PLASTIC TSSOP (T6R) (UNIT: mm)

Technical drawing of a mechanical part, likely a bracket or support, showing dimensions and tolerances. The drawing includes a main view and a side view.

Dimensions and Tolerances:

- Overall width: 1.0 ± 0.1
- Overall height: 1.0 ± 0.1
- Top horizontal distance from left edge to center: 0.13 ± 0.07
- Top horizontal distance from center to right edge: 0.175 ± 0.075
- Bottom horizontal distance from left edge to center: 0.23 ± 0.07
- Bottom horizontal distance from center to right edge: 0.175 ± 0.075
- Right side width: $0.37^{+0.03}_{-0.05}$
- Top vertical distance from top edge to center: 0.35 ± 0.06
- Top vertical distance from center to bottom edge: 0.35 ± 0.06
- Top vertical distance from bottom edge to center: 0.45 ± 0.1
- Top vertical distance from center to top edge: $0.15^{+0.07}_{-0.05}$
- Top vertical distance from top edge to center: 0.08 MIN.
- Top vertical distance from center to top edge: 0.08 MIN.
- Top vertical distance from top edge to center: 0.08 MIN.

7

RECOMMENDED SOLDERING CONDITIONS

This product should be soldered and mounted under the following recommended conditions. For soldering methods and conditions other than those recommended below, contact your nearby sales office.

Soldering Method	Soldering Conditions	Condition Symbol
Infrared Reflow	Peak temperature (package surface temperature) : 260°C or below Time at peak temperature : 10 seconds or less Time at temperature of 220°C or higher : 60 seconds or less Preheating time at 120 to 180°C : 120±30 seconds Maximum number of reflow processes : 3 times Maximum chlorine content of rosin flux (% mass) : 0.2%(Wt.) or below	IR260
Wave Soldering	Peak temperature (molten solder temperature) : 260°C or below Time at peak temperature : 10 seconds or less Preheating temperature (package surface temperature) : 120°C or below Maximum number of flow processes : 1 time Maximum chlorine content of rosin flux (% mass) : 0.2%(Wt.) or below	WS260
Partial Heating	Peak temperature (terminal temperature) : 350°C or below Soldering time (per side of device) : 3 seconds or less Maximum chlorine content of rosin flux (% mass) : 0.2%(Wt.) or below	HS350

Caution Do not use different soldering methods together (except for partial heating).

Not recommended for new design

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